

Block Move Optimization Techniques Series 32000® Graphics Note 2

National Semiconductor
Application Note 526
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1.0 INTRODUCTION

This application note discusses fast methods of moving data in printer applications using the National Semiconductor Series 32000. Typically this data is moved to or from the band of RAM representing a small portion (or slice) of the total image. The length of data is fixed. The controller design may require moving data every few milliseconds to image the page, until a total of 1 page has been moved. This may be (at 300 DPI, for example) $(8.5 \times 300) \times (11 \times 300)$, or 1,051,875 bytes. In current controller designs the width is often rounded to a word boundary (usually 320 bytes at 300 DPI). This technique uses 1,056,000 bytes, or 528,000 words.

2.0 DESCRIPTION

The move string instructions (MOVSi) in the 32000 are very powerful, however, when all that is needed is a string copy, they may be overkill. The string instructions include string translation, conditionals and byte/word/double sizes. If the application needs only to move a block of data from one location to another, and that data is a known size (or at least a multiple of a known size), using unrolled MOVD instructions is a faster way of moving the data from A to B on the NS32032 and NS32332.

3.0 IMPLEMENTATION

A code sample follows which makes use of a block size of 128 bytes. To move 256 bytes, for example, R0 should contain 2 on entry.

```
; Version 1.0 Sun Mar 29 12:57:20 1987
;
;A subroutine to move blocks of memory. Uses a granularity of
;128 bytes.
;
;   Inputs:
;       r0 = number of 128 byte blocks to move
;       r1 = source block address
;       r2 = destination block address
;
;Listing continues on following page
;
```

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;      Outputs:
;      r0 = 0
;      r1 = source block address + (128 * blocks)
;      r2 = destination block address + (128 * blocks)
;
;Notes:
;      This algorithm corresponds closely to the MOVSD instruction,
;      except that r0 contains the number of 128 byte blocks, not
;      4 byte double words. The output values are the same as if a
;      MOVSD instruction were used.
;
movmem: cmpq    0,r0                ;if no blocks to move
        beq     mvexit             ;exit now.
        .align 4
mvlp1:  movd    0(r1),0(r2)         ;move one block of data
        movd    4(r1),4(r2)
        movd    8(r1),8(r2)
        movd    12(r1),12(r2)
        movd    16(r1),16(r2)
        movd    20(r1),20(r2)
        movd    24(r1),24(r2)
        movd    28(r1),28(r2)
        movd    32(r1),32(r2)
        movd    36(r1),36(r2)
        movd    40(r1),40(r2)
        movd    44(r1),44(r2)
        movd    48(r1),48(r2)
        movd    52(r1),52(r2)
        movd    56(r1),56(r2)
        movd    60(r1),60(r2)
        movd    64(r1),64(r2)
        movd    68(r1),68(r2)
        movd    72(r1),72(r2)
        movd    76(r1),76(r2)
        movd    80(r1),80(r2)
        movd    84(r1),84(r2)
        movd    88(r1),88(r2)
        movd    92(r1),92(r2)
        movd    96(r1),96(r2)
        movd    100(r1),100(r2)
        movd    104(r1),104(r2)
        movd    108(r1),108(r2)
        movd    112(r1),112(r2)
        movd    116(r1),116(r2)
        movd    120(r1),120(r2)
        movd    124(r1),124(r2)
        addr    128(r1),r1         ;quick way of adding 128
        addr    128(r2),r2
        acbd    -1,r0,mvlp1       ;loop for rest of blocks
mvexit: ret     $0

```

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4.0 TIMING

All timing assumes word aligned data (double word aligned for 32-bit bus). Unaligned data is permitted, but will reduce the speed.

On the 32532 (no wait states, @ 30 MHz, 32-bit bus), this code executes in 204 clocks, assuming burst mode access is available. To move 256 bytes, this routine would take 13.6 μ s. The MOVSD instruction takes about 156 clocks to move a 128-byte block. The MOVSD instruction is the best choice, therefore, on the 32532.

On the 32332 (no wait states, @ 15 MHz, 32-bit bus), this code executes in 458 clocks per 128-byte block. Thus, to move 256 bytes, this algorithm takes 61.1 μ s. The loop overhead (the ADDR and ACBD instructions) is about 10%. Doubling the block size (to 256 bytes) would reduce the loop overhead to 5%, and reducing the block size (to 64 bytes) would increase the loop overhead to 20%. In comparison, the 32332 MOVSD instruction takes about 721 clocks to move a 128-byte block.

On the 32032 (no wait states, @ 10 MHz, 32-bit bus), this code executes in 634 clocks per 128-byte block. Thus, to

move 256 bytes, this algorithm takes 126.8 μ s. The loop overhead (the ADDR and ACBD instructions) is about 5%. Doubling the block size (to 256 bytes) would reduce the loop overhead to 2.5%, and reducing the block size (to 64 bytes) would increase the loop overhead to 10%. In comparison, the 32032 MOVSD instruction takes about 690 clocks to move a 128-byte block.

On the 32016 (1 wait state, @ 10 MHz, 16-bit bus), this code executes in 1150 clocks per 128-byte block. Thus, to move 256 bytes, this algorithm takes 230.0 μ s. The loop overhead on the 32016 is about 2.5%. In comparison, the 32016 MOVSD instruction would take about 1,074 clocks. Thus, the MOVSD instruction is faster, and makes better use of the available bus bandwidth of the NS32016.

5.0 CONCLUSIONS

The MOVSi instructions on the NS32016 provide a very fast memory block move capability, with variable size. On the NS32332 and NS32032, however, unrolled MOVD instructions are faster due to the larger bus bandwidth of the NS32332 and NS32032.

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